

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSVI)

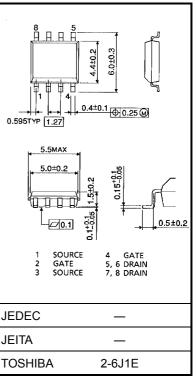
TPC8202

Lithium Ion Battery Applications Portable Equipment Applications Notebook PCs

- 2.5-V Gate drive
- Small footprint due to small and thin package
- Low drain-source ON resistance $: R_{DS} (ON) = 41 \text{ m}\Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 9 S (typ.)$
- Low leakage current $: I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 20 \ V)$
- Enhancement-mode $: V_{th} = 0.5 \sim 1.1 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 200 \text{ }\mu\text{A})$

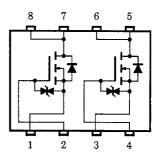
Char	acteristics	Symbol	Rating	Unit	
Drain-source vol	tage	V _{DSS}	20	V	
Drain-gate voltag	ge (R _{GS} = 20kΩ)	V _{DGR}	20	V	
Gate-source volt	age	V _{GSS}	±12	V	
	D C (Note 1)	ID	5		
Drain curren	Pulse (Note 1)	I _{DP}	20	A	
Drain power dissipation (t = 10s) (Note 2a)	Single-device operation (Note 3a)	P _{D (1)}	1.5	W	
	Single-device value at dual operation (Note 3b)	P _{D(2)}	1.1		
Drain power dissipation (t = 10s)	Single-device operation (Note 3a)	P _{D (1)}	0.75	W	
	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.45		
Single pulse ava	lanche energy (Note 4)	E _{AS}	32.5	mJ	
Avalanche curre	nt (Note 1)	I _{AR}	5	А	
Repetitive avalar Single-device va (Note		E _{AR}	AR 0.1		
Channel tempera	ature	T _{ch}	150	°C	
Storage tempera	ture range	T _{stg}	-55~150	°C	

Maximum Ratings (Ta = 25°C)



Weight: 0.080 g (typ.)

Circuit Configuration



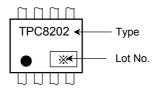
Note: For (Note 1), (Note 2a), (Note 2b), (Note 3a), (Note 3b), (Note 4) and (Note 5) please refer to the next page. This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10s) (Note 2a)	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	83.3	
	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)}	114	°C/W
	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	167	0,00
Thermal resistance, channel to ambient (t = 10s) (Note 2b)	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)}	278	

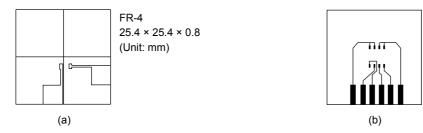
Marking (Note 6)



Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:

- a) Device mounted on a glass-epoxy board (a)
- b) Device mounted on a glass-epoxy board (b)



FR-4 25.4 × 25.4 × 0.8 (Unit: mm)

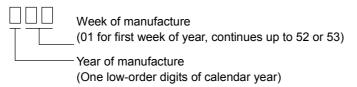
Note 3:

- a) The power dissipation and thermal resistance values are shown for a single device (During single-device operation, power is only applied to one device.).
- b) The power dissipation and thermal resistance values are shown for a single device (During dual operation, power is evenly applied to both devices.).

Note 4: V_{DD} = 16 V, T_{ch} = 25°C (initial), L = 1.0 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 5: Repetitive rating; pulse width limited by maximum channel temperature.

- Note 6: on lower right of the marking indicates Pin 1.
 - ※ Weekly code:(Three digits)



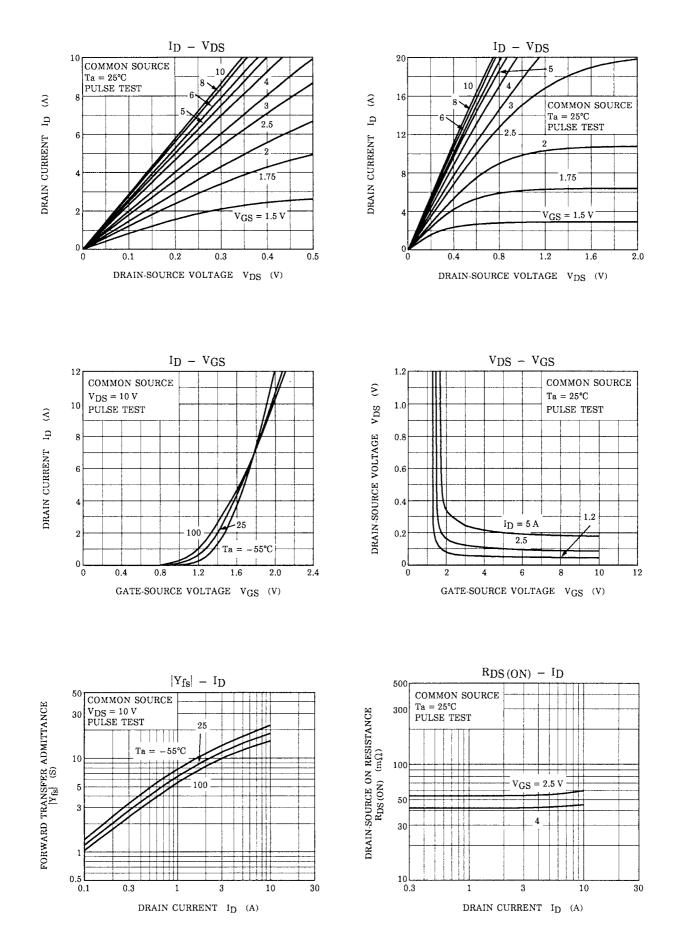
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±10 V, V _{DS} = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	_	_	10	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	20	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 200 μA	0.5	_	2.0	V
<u> </u>		R _{DS (ON)}	V _{GS} = 2.5 V, I _D = 2.5 A	— 53 70		70	mΩ
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 4 V, I _D = 2.5 A	- - 10 20 - - 0.5 - 2.0	mΩ		
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	4	9	_	S
Input capacitance		C _{iss}		_	570	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	80	_	pF
Output capacitance		C _{oss}		_	285	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10 \text{ V}}{_{0 \text{ V}}} \int_{\mathcal{C}} \stackrel{I_{D} = 2.5 \text{ A}}{_{VOUT}} \\ \stackrel{\circ}{_{C}} $	_	21	_	
	Turn-on time	t _{on}		_	30		
	Fall time	t _f			19	_	ns
	Turn-off time	t _{off}	$V_{DD} \rightleftharpoons 10 V$ Duty $\leq 1\%$, t _w = 10 μ s	_	110	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	13	_	nC
Gate-source charge		Q _{gs}	V _{DD} ≈ 16 V, V _{GS} = 5 V, I _D = 5 A	_	8	_	
Gate-drain ("miller") charge		Q _{gd}]	_	5	—	

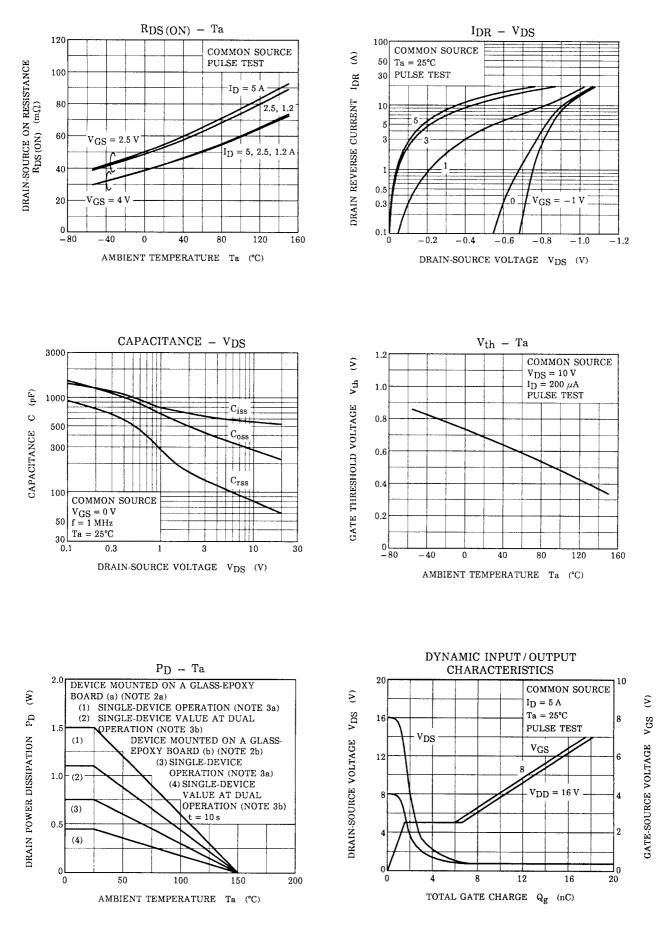
Source–Drain Ratings and Characteristics (Ta = 25°C)

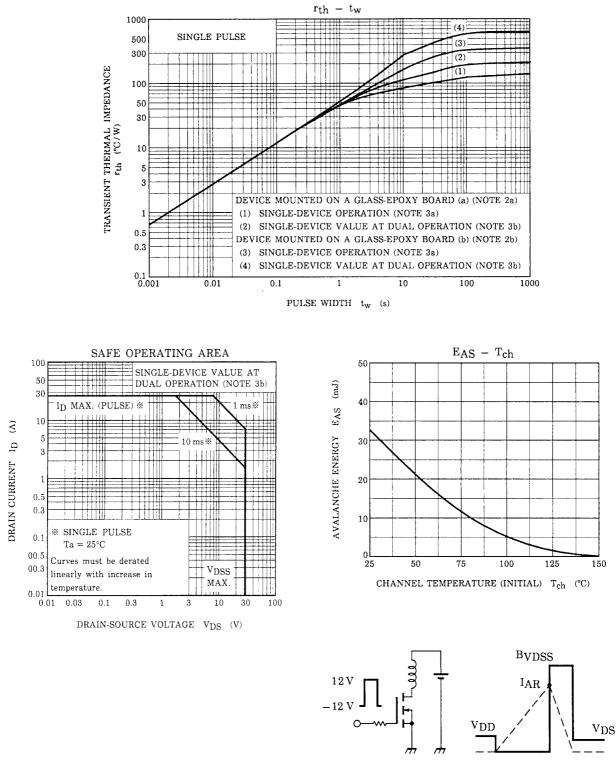
Charact	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	_	_	20	А
Forward voltage	(diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V		-	-1.2	V

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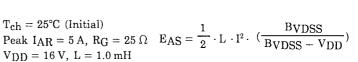


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TEST CIRCUIT



WAVE FORM

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